

Austria	Bertagnolli	Emmerich	Vienna University of Technology
Austria	Glinsner	Thomas	EVGroup
Austria	Hudek	Peter	Vorarlberg Univ. of Applied Science
Austria	Lang	Wolfgang	University of Vienna
Austria	Leising	Günther	Joanneum Research Forschungsgesellschaft
Austria	Loeschner	Hans	IMS Nanofabrication
Austria	Minixhofer	Rainer	austriamicrosystems
Austria	Osanna	P. Herbert	Vienna University of Technology
Austria	Stangl	Günther	Vienna University of Technology
Austria	Strasser	Gottfried	TU Wien
Belgium	Leunissen	Leo H.A.	IMEC
Belgium	Tilmans	Harrie	IMEC
Brazil	Prioli	Rodrigo	PUC - Rio
Bulgaria	Mladenov	Georgy	Bulgarian Academy of Sciences
Bulgaria	Nikolov	Nikolay	Microsystems, LTD
Bulgaria	Vutova	Katia	Bulgarian Academy of Sciences
Canada	Bogdanov	Alexei	National Research Council Canada
China	Liu	Zhuming	Chinese Academy of Sciences
Cyprus	Doumanidis	Haris	University of Cyprus, Mechanical & Manuf. Eng.
Denmark	Boisen	Anja B.	Technical University of Denmark
Denmark	Kristensen	Anders	Technical University of Denmark
Finland	Ahopelto	Jouni	VTT Information Technology
France	Bourgoin	Jean-Philippe	CEA-SPEC CEA-Saclay
France	Cardinaud	Christophe	CNRS - IMN
France	Chen	Yong	CNRS - LPN
France	Gierak	Jacques	CNRS - LPN
France	Joubert	Olivier	CNRS - LTM
France	Louis	Didier	CEA-G / LETI
France	Perrocheau	Jacques	JEMI France
France	Purcell	Stephen	Centre Nationale de la Recherche Scientifique
France	Tedesco	Serge	CEA - LETI
France	Vieu	Christophe	CNRS - LAAS
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Germany	Henschel	Wolfgang	University of Tübingen
Germany	Hillmer	Hartmut	University of Kassel
Germany	Hoenlein	Wolfgang	Infineon Technologies
Germany	Kamm	Frank-Michael	Infineon Technologies
Germany	Kern	Dieter	University of Tübingen
Germany	Kienzle	Oliver	Carl Zeiss SMS
Germany	Knapp	Konrad	Schott Lithotec AG
Germany	Letzkus	Florian	Inst. Microelectronics Stuttgart
Germany	Rangelow	Ivo W.	University of Kassel
Germany	Reithmaier	Johann Peter	University of Kassel
Germany	Reng	Norbert	Carl Zeiss NTS
Germany	Ryssel	Heiner	Fraunhofer Institute IISB
Germany	Scheer	Hella C.	University of Wuppertal
Germany	Stolberg	Ines	Leica Microsystems
Germany	Stuke	Michael	Max Planck Institute Göttingen

Greece	Argitis	Panagiotis	NCSR Demokritos
Greece	Gogolides	Evangelos	NCSR Demokritos
Greece	Normand	Pascal	NCSR Demokritos
Greece	Tsoukalas	Dimitris	National Techn. Univ. of Athens
Hungary	Bársony	István	Hungarian Academy of Sciences
India	Dev	Bhupendra N.	Institute of Physics
Ireland	Sotomayor Torre:	Clivia M.	NMRC University College Cork
Israel	Kolodney	Eli	Technion
Italy	De Vittorio	Massimo	Univ. Of Lecce National Nanotechnology Lab.
Italy	Di Fabrizio	Enzo	TASC - INFM
Italy	Gentili	Massimo	Pirelli Laboratories
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Japan	Suzuki	Kazuaki	Nikon
Japan	Matsui	Shinji	University of Hyogo
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Korea	Ahn	Jinho H.	Hanyang Univ.
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Lithuania	Snitka	Valentinas	Kaunas University of Technology
Netherlands	de Jager	Patrick	TNO-TPD
Netherlands	Graef	Mart	Philips SC
Netherlands	Herre	Van Der Zant	Tudelft
Netherlands	Kruit	Pieter	Delft University of Technology
Netherlands	Luttge	Regina	University of Twente
Netherlands	Van Delft	Falco C.M.	Philips Research Laboratories
Netherlands	Van der Drift	Emile	Technical University of Delf
New Zealand	Alkaisi	Maan M.	University of Canterbury
Poland	Grabiec	Piotr B.	Institute of Electron Technology
Portugal	Barradas	Nuno P.	Instituto Tecnológico Nuclear
Romania	Gheorghiu	Eugen	International Centre of Biodynamic
Russia	Latyshev	Alexander	Inst of SC Physics Novosibirsk
Russia	Zaitsev	Sergey I.	Institute of Microelectronics Techn
Serbia & Mor	Djuric	Zoran	IHTM - Inst. Microelectr. Techn. & Single Cry.
Singapore	Khursheed	Anjam	National University of Singapore
Slovak Republ	Drzik	Milan	International Laser Center
Slovak Republ	Kostic	Ivan	Slovak Academy of Sciences
Slovenia	Mraz	Miha	University of Ljubljana
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Spain	Azcárate	Sabino	Tekniker
Spain	Barniol	Nuria	Universitat Autònoma de Barcelona
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Spain	Calleja	Montserrat	CNM-IMM
Spain	Cornet	Albert	Universitat de Barcelona
Spain	De Teresa	Jose Maria	ICMA Facultad de Ciencias
Spain	Lechuga	Laura	CNM-IMM
Spain	Lora-Tamayo	Emilio	UAB/CNM-IMB
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Spain	Pérez-Murano	Francesc	CNM-IMB
Spain	Samitier	Josep	Universitat de Barcelona-IBEC

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Switzerland	Despont	Michel	IBM Research Laboratory
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Switzerland	Heyderman	Laura	Paul Scherrer Institute
Switzerland	Ionescu	Adrian	EPF Lausanne
Switzerland	Nellen	Philipp M	EMPA
Switzerland	Staufer	Urs	University of Neuchatel
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UK	Hasko	David G.	University of Cambridge
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UK	Robinson	Alex P.G.	University of Birmingham
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USA	Steen	Steven	IBM Research Yorktown Heights
USA	Willson	Grant	The University of Texas
USA	Wurm	Stefan	SEMATECH - Infineon